

/ Revised record

A	2019-7-23	all	SMA-S-SS52_SS520-5A200V		
B	2021-3-16	2 4 7	V_F SS58 0.7 V_F SS58 0.85 5 50000 7 70000 340X340X40、 350X350X230 336X336X40、 380X335X366		

/ Descriptions

20V~200V 5.0A SMA
Surface Mount Schottky Barrier Rectifiers, Reverse Voltage 20 to 200V, Forward Current: 5.0A ,SMA package.

/ Features

RoHS 2011/65/EU

Low power loss, high efficiency High forward surge current capability Lead free in comply with EU RoHS 2011/65/EU directives, For surface mounted applications. HF product.

/ Applications

General purpose.

/ Equivalent Circuit

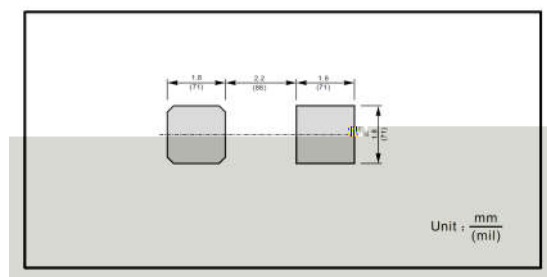


/ Pinning



PIN	DESCRIPTION
1	Cathode
2	Anode

The recommended mounting pad size



/ Marking

See Marking Instructions.

Parameter	Symbol	Rating								Unit
		SS52	SS54	SS56	SS58	SS510	SS512	SS515	SS520	
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	40	60	80	100	120	150	200	V
Maximum RMS voltage	V_{RMS}	14	28	42	56	70	84	105	140	V
Maximum DC Blocking Voltage	V_{DC}	20	40	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	5.0								A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	120								A
Typical Junction Capacitance ¹⁾	C_j									

/ Electrical Characteristic Curve

Fig.1 Forward Current Derating Curve

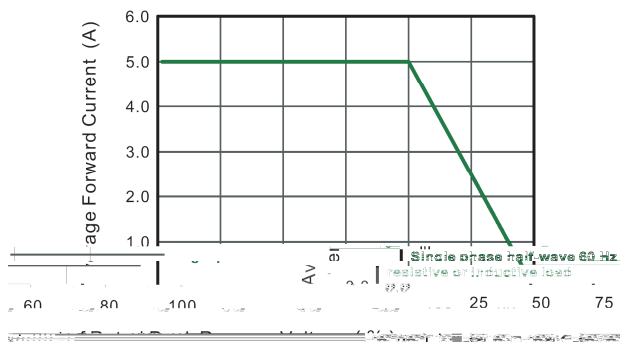


Fig.2 Typical Reverse Characteristics

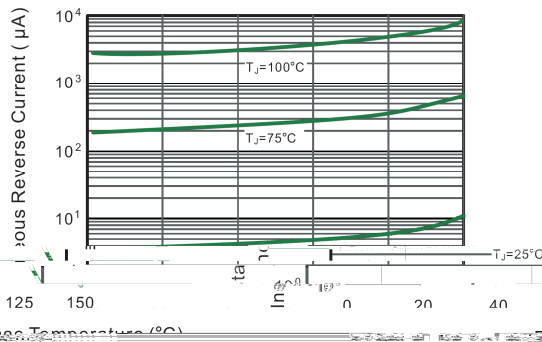


Fig.3 Typical Forward Characteristic

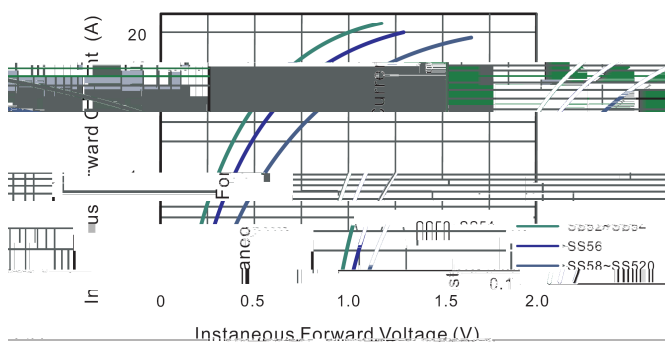


Fig.4 Typical Junction Capacitance

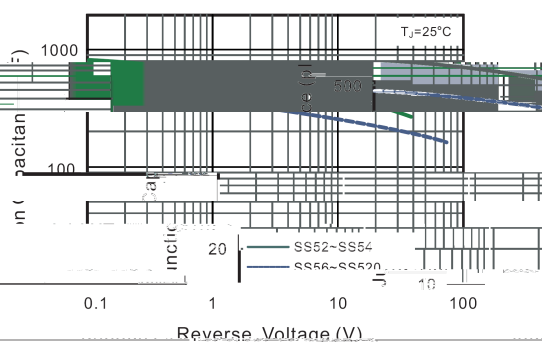


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

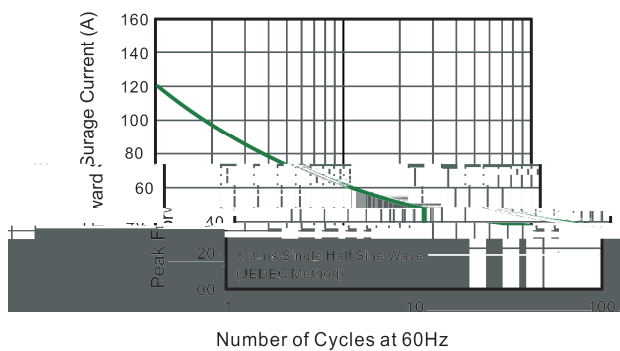
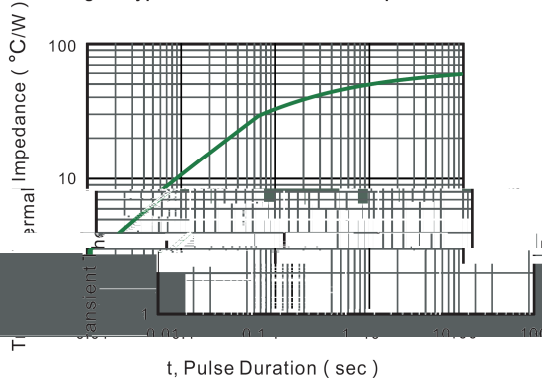
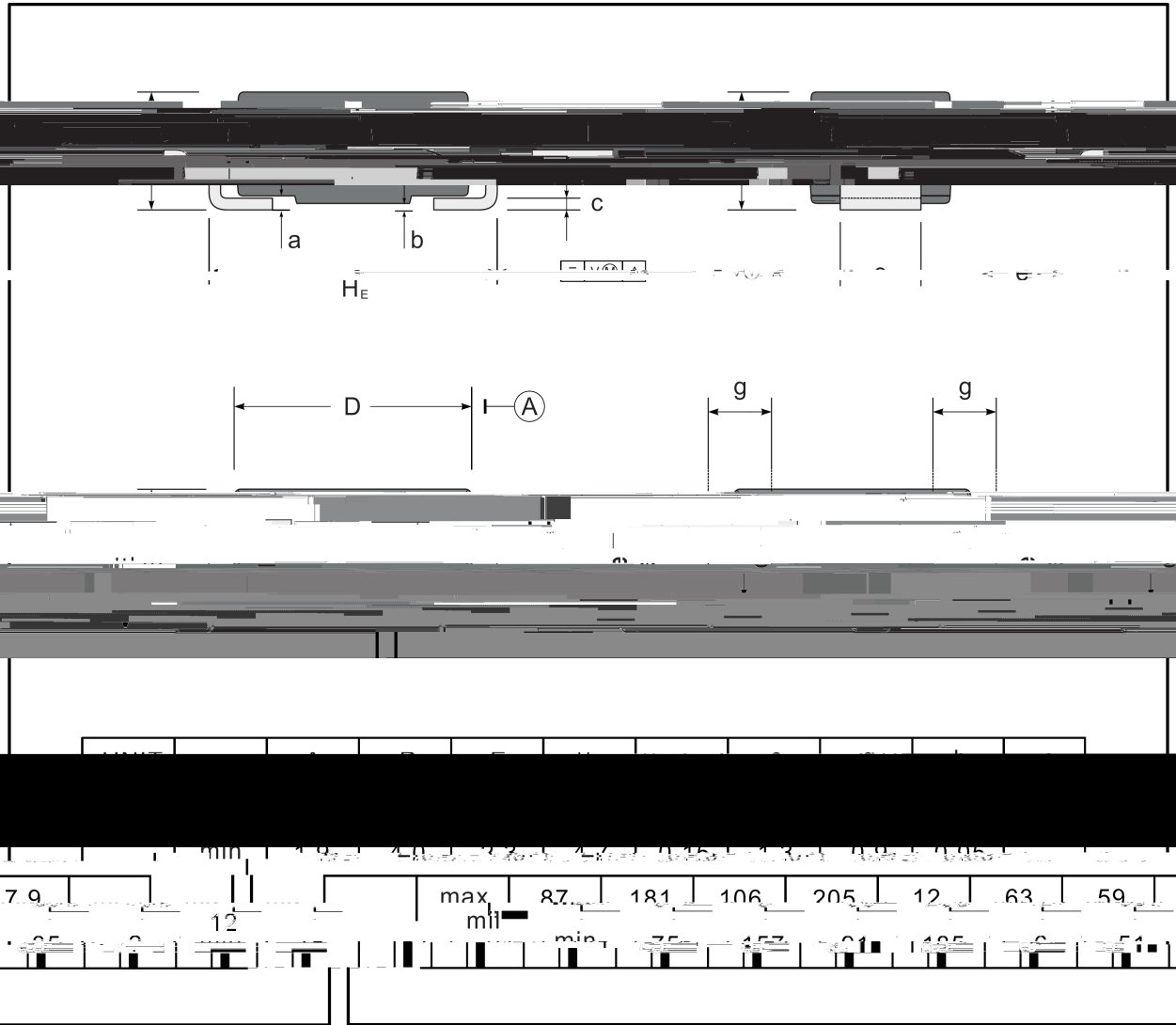


Fig.6- Typical Transient Thermal Impedance



/ Package Dimensions

SMA



Marking

Type number	Marking code
SS52	SS52
SS54	SS54
SS56	SS56
SS58	SS58
SS510	SS510
SS512	SS512
SS515	SS515
SS520	SS520

/ Marking Instructions



SS52

1 *

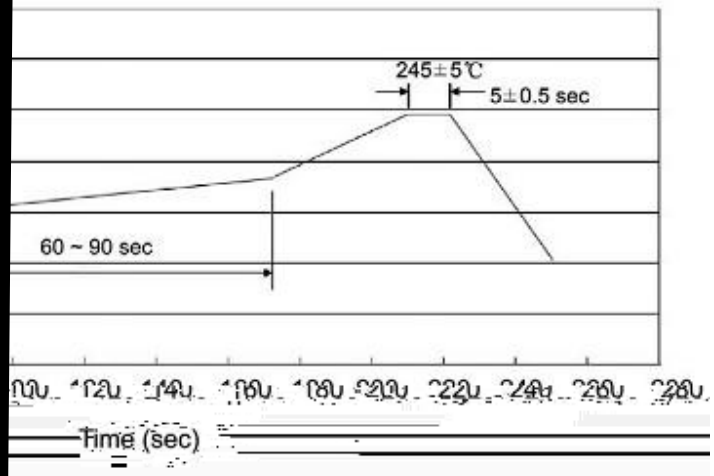
3 *

Note:

SS52 Product Type Code

**** Lot No. Code The 1st * means:YM Code The last 3 * means:little Lot No
Code

Reflow Profile for IR Reflow Soldering(Pb-Free)



Note:

1. Preheating: 150~180 °C, Time: 60~90 sec.
2. Peak Temp.: 245±5 °C, Duration: 5±0.5 sec.
3. Cooling Speed: 2~10 °C/sec.

Soldering Heat Test Conditions

Temp.: 260±5 °C

Time: 10±1 sec

Quantity 数量		Dimension 包装尺寸 (unit: mm ³)	
Inner Boxes/Outer Box	Units/Outer Box		